

August 2012 SuperFET[®] II

FCU900N60Z 600V N-Channel MOSFET

FCU900N60Z 600V N-Channel MOSFET

Features

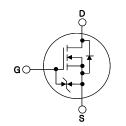
- 675V @T_J = 150°C
- Max. R_{DS(on)} = 900mΩ
- Ultra Low Gate Charge (Typ. Q_g = 13nC)
- Low Effective Output Capacitance (Typ. C_{oss}.eff = 49pF)
- 100% Avalanche Tested
- ESD Improved Capacity

Description

SuperFET[®]II is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET[®]II is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	Parameter		Rating	Units	
V _{DSS}	Drain to Source Voltage			600	V
V _{GSS}	Gate to Source Voltage	-DC		±20	V
		-AC	(f>1Hz)	±30	V
I _D	Drain Current	-Continuous ($T_C = 25^{\circ}C$)		4.5	Α
		-Continuous (T _C = 100 ^o C)		2.8	
I _{DM}	Drain Current	- Pulsed	(Note 1)	13.5	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		47.5	mJ	
I _{AR}	Avalanche Current (N		(Note 1)	1	A
E _{AR}	Repetitive Avalanche Energy (N		(Note 1)	0.52	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)			20	V/ns
uv/ut	MOSFET dv/dt			100	
P _D	Power Dissipation	$(T_{C} = 25^{\circ}C)$		52	W
		- Derate above 25°C		0.42	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

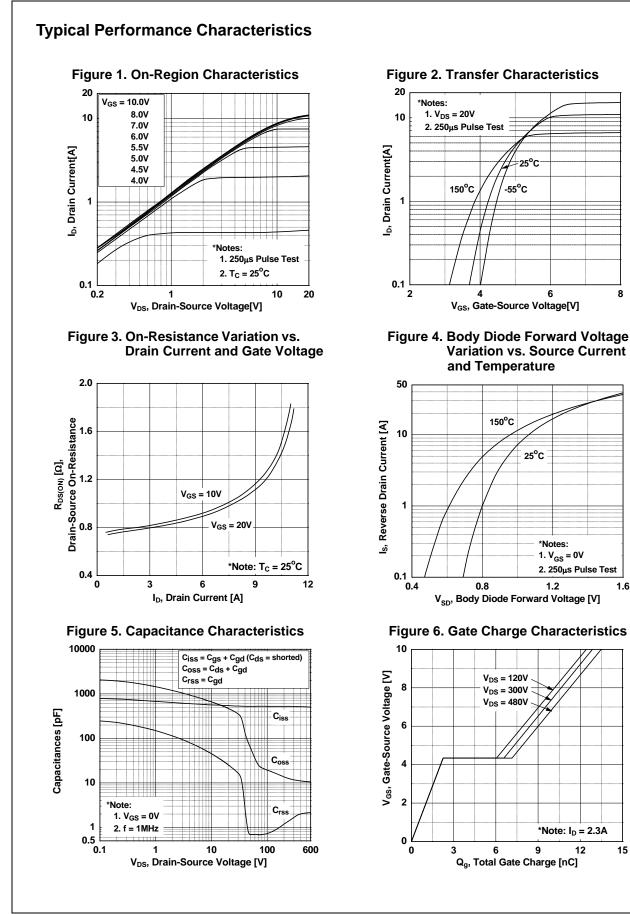
Thermal Characteristics

Symbol	Parameter	Rating	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.4	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	100	°C/vv

Device MarkingDevicePackageFCU900N60ZFCU900N60ZI-PAK		e Reel Size	Таре	e Width		Quanti	ty		
		-		-		75			
Electrica	Char	acteristics T _c =	25ºC unless	otherwise noted					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Units
Off Charac	teristic	s							
		-		$I_{D} = 1 \text{mA}, V_{GS} = 0 \text{V}, T_{J} = 2$	25°C	625	-	-	V
BV _{DSS}	Drain to Source Breakdown Voltage		$I_D = 1mA$, $V_{GS} = 0V$, $T_J = 1$		675	-	-	V	
ΔBV _{DSS} ΔT.I			$I_D = 1$ mA, Referenced to 25°C		-	0.72	-	V/ºC	
BV _{DS}		o Source Avalanche	e Breakdown	V _{GS} = 0V, I _D = 4.5A		-	700	-	V
	Ŭ	•		V _{DS} = 600V, V _{GS} = 0V		-	-	1	
DSS	Zero Ga	ate Voltage Drain Curre	ent	$V_{\rm DS} = 600V, V_{\rm CS} = 0V$ $V_{\rm DS} = 600V, T_{\rm C} = 125^{\circ}{\rm C}$		-	-	10	μA
GSS	Gate to	Body Leakage Curren	nt	$V_{GS} = \pm 20V, V_{DS} = 0V$		-	-	±10	μA
On Charac									
V _{GS(th)}	T	reshold Voltage		$V_{GS} = V_{DS}, I_{D} = 250 \mu A$		2.5	_	3.5	V
R _{DS(on)}		rain to Source On Res	sistance	$V_{GS} = 10V, I_D = 2.3A$		-	0.82	0.90	Ω
9FS	Forward Transconductance		$V_{DS} = 20V, I_D = 2.3A$	(Note 4)	-	4.6	-	S	
Dynamic C	haracte	Pristics							
C _{iss}	-	apacitance				-	534	710	pF
C _{oss}	-	Capacitance		V _{DS} = 25V, V _{GS} = 0V f = 1MHz		-	399	530	pF
S _{oss}	-	e Transfer Capacitance	è			-	19.7	30	pF
C _{oss}		out Capacitance		V _{DS} = 380V, V _{GS} = 0V, f =	1.0MHz	-	11.1	-	pF
C _{oss} eff.		e Output Capacitance		$V_{DS} = 0V$ to 480V, $V_{GS} = 0$		-	48.6	-	pF
Q _{g(tot)}		ate Charge at 10V		$V_{DS} = 380V, I_D = 2.3A$ $V_{GS} = 10V$ (Note 4) Drain open		-	13.1	17	nC
Q _{gs}	Gate to	Source Gate Charge				-	2.2	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge				-	4.5	-	nC
ESR		ent Series Resistance				-	2.4	-	Ω
									55
Switching	1			T				1	-1
t _{d(on)}		Delay Time		$V_{DD} = 380V, I_D = 2.3A$ $V_{GS} = 10V, R_G = 4.7\Omega$		-	10.9	32	ns
t _r		Rise Time				-	5.3	21	ns
t _{d(off)}		Delay Time				-	33.6	77	ns
t _f					(Note 4)	-	11.9	34	ns
	1	le Characteristic				-		4.5	A
ls	Maximum Continuous Drain to Source Diode Forward Current Maximum Pulsed Drain to Source Diode Forward Current					-	-	13.5	A
SM Vod				$V_{GS} = 0V, I_{SD} = 2.3A$		_	-		V
			a vonago	$V_{GS} = 0V, I_{SD} = 2.3A$ $V_{GS} = 0V, I_{SD} = 2.3A$		_	156	-	ns
				$dI_{F}/dt = 100A/\mu s$	(Note 4)	-		-	nC
	Reverse Reverse	Source Diode Forward Recovery Time Recovery Charge		$V_{GS} = 0V,$	I _{SD} = 2.3A	I _{SD} = 2.3A		I _{SD} = 2.3A - 156	- 156 -

8

1.6



FCU900N60Z Rev. C0

15

vs. Temperature

-40

 $R_{\theta JC} = 1.5^{\circ}C/W$

0

40

T_J, Junction Temperature [^oC]

*Notes:

80

V_{GS} = 10V

50 75 100 T_C, Case Temperature [[°]C]

1. V_{GS} = 10V

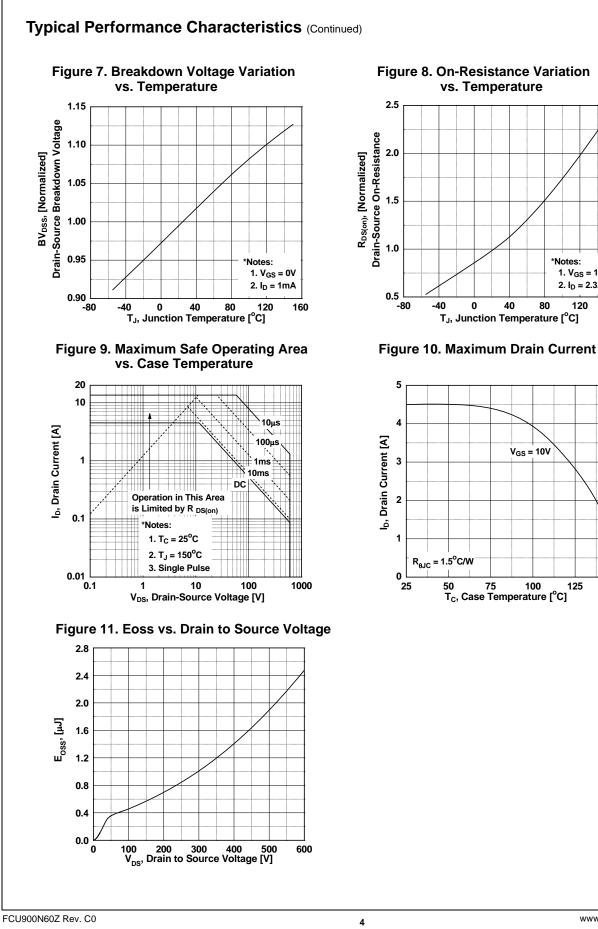
2. I_D = 2.3A

120

125

150

160

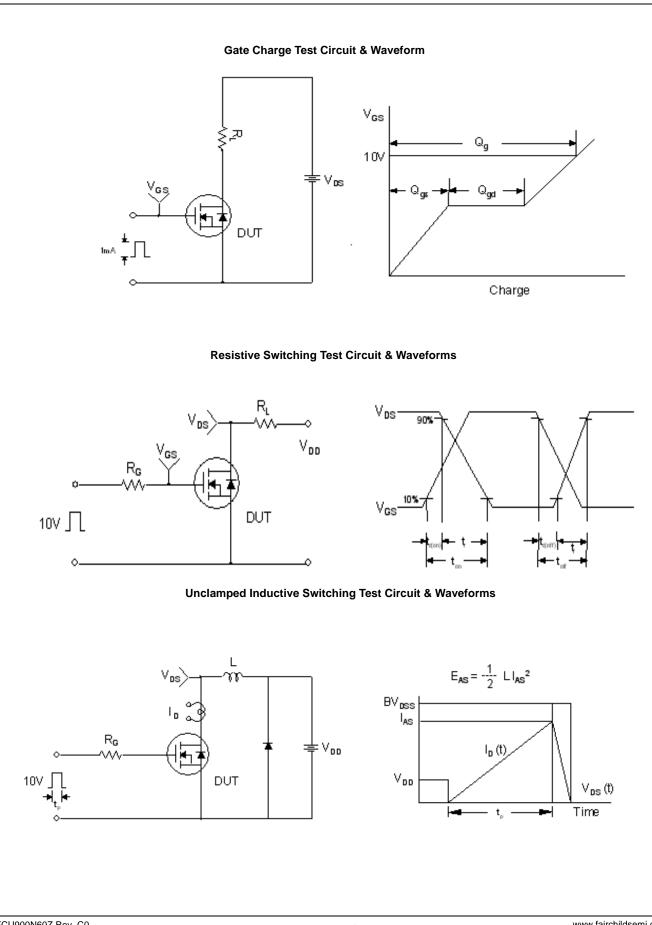


www.fairchildsemi.com

FCU900N60Z 600V N-Channel MOSFET

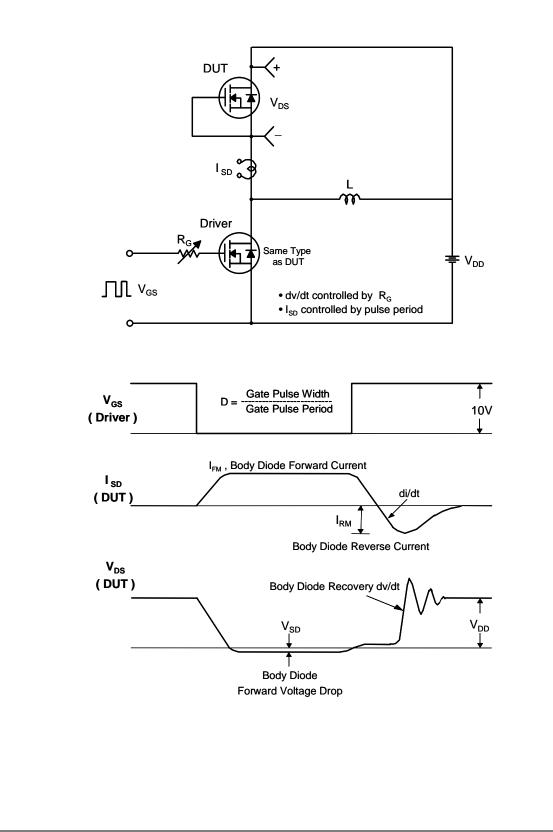
Typical Performance Characteristics (Continued) Figure 12. Transient Thermal Response Curve 3 Thermal Response [Z_{euc}] 1 P_{DM} ۰ 0 0.05 Notes 0.02 1. $Z_{\theta,JC}(t) = 2.4^{\circ}C/W$ Max. 2. Duty Factor, $D = t_1/t_2$ 3. T_{JM} - $T_C = P_{DM} * Z_{\theta JC}(t)$ 0.1 . 10⁻⁵ 10⁻⁴ **10**⁻¹ 10⁻³ 10⁻² 10[°] Rectangular Pulse Duration [sec]

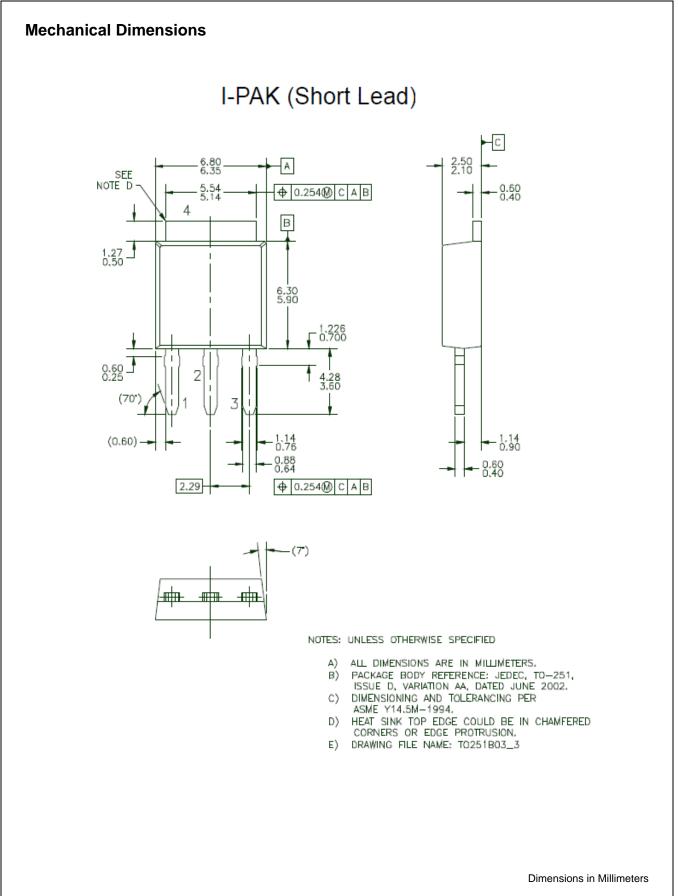
FCU900N60Z 600V N-Channel MOSFET



FCU900N60Z 600V N-Channel MOSFET









SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

		®	@
2Cool™	F-PFS™	PowerTrench [®]	The Power Franchise [®]
AccuPower™	FRFET®	PowerXS™	the ®
AX-CAP™*	Global Power Resource SM	Programmable Active Droop [™]	puwer
BitSiC [®]	Green Bridge™	QFET®	franchise TinyBoost™
Build it Now™	Green FPS [™]	QS™	
CorePLUS™	Green FPS™ e-Series™	Quiet Series [™]	TinyBuck™
CorePOWER™	G <i>max</i> ™	RapidConfigure™	TinyCalc™
CROSSVOLT™	GTO™	TM	TinyLogic®
CTL™	IntelliMAX™	\sim	TINYOPTO™
Current Transfer Logic™	ISOPLANAR™	Saving our world, 1mW/W/kW at a time™	TinyPower™
DEUXPEED®	Marking Small Speakers Sound Louder		TinyPWM™
Dual Cool™	and Better TM	SmartMax™	TinyWire™
EcoSPARK [®]	MegaBuck [™]	SMART START™	TranSiC®
			TriFault Detect [™]
EfficentMax™	MICROCOUPLER™	Solutions for Your Success™	TRUECURRENT [®] *
ESBC™	MicroFET™	SPM®	uSerDes™
e	MicroPak™	STEALTH™	
+	MicroPak2 [™]	SuperFET [®]	SerDes
Fairchild®	MillerDrive™	SuperSOT™-3	
Fairchild Semiconductor®	MotionMax [™]	SuperSOT™-6	UHC [®]
FACT Quiet Series™	Motion-SPM [™]	SuperSOT™-8	Ultra FRFET™
FACT	mWSaver™	SupreMOS®	UniFET™
FAST [®]	OptoHiT™	SyncFET™	VCX™
	OPTOLOGIC®	Sync-Lock™	VisualMax™
FastvCore™	OPTOPLANAR®		VoltagePlus™
FETBench™	OFTOFLANAR	- STSIEM	XS™
FlashWriter [®] *	®	GENERAL	
FPS™	-		

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCI AIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE COODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or 2. system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 161